

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
Neil Mclellan		08/28/2007
Adam Zbrzezny		08/28/2007
RECEIVING PARTY DATA		
Name:	ATI Technologies ULC	
Street Address:	1 Commerce Valley Drive East	
City:	Markham, Ontario	
State/Country:	CANADA	
Postal Code:	L3T 7X6	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11847101	
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ATTORNEY DOCKET NUMBER:	070039	
NAME OF SUBMITTER:	Christopher J. Reckamp	
Total Attachments: 2 source=11847101_Assignment#page1.tif source=11847101_Assignment#page2.tif		

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PATENT

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REEL: 019972 FRAME: 0529

ASSIGNMENT

WHEREAS, we, *Neil MCLELLAN* and *Adam ZBRZEZNY*, whose full post office addresses are *2 Reon Drive, #2104, Toronto, Ontario, M2K 3B8, Canada*, and *64 Conference Blvd., Scarborough, Ontario, M1C 2E3, Canada*, has invented an invention entitled *WAFER LEVEL PACKAGING OF SEMICONDUCTOR CHIPS* for which an application for a patent is about to be filed in the United States;

AND WHEREAS, *ATI Technologies U.L.C.*, whose full post office address is *1 Commerce Valley Drive East, Markham, ON., L3T 7N6 CANADA*, is desirous of acquiring an interest therein;

AND WHEREAS, the serial number and filing date of the U.S. application, when assigned, should be entered here following:

Serial No.: 11/847,101

Filing Date: August 29, 2007

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we, *Neil MCLELLAN* and *Adam ZBRZEZNY*, by these presents do sell, assign, and transfer, and do hereby confirm the sale, assignment, and transfer unto *ATI Technologies U.L.C.* of our full, right, title, and interest for the United States of America and all other countries foreign thereto, in, and to the said invention, as described in the said application; said invention, said application, any other applications for Letters Patent for said invention, and all Letters Patent issuing from such applications, to be held and enjoyed by the *ATI Technologies U.L.C.*, for its own use and benefit and for its legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

We, *Neil MCLELLAN* and *Adam ZBRZEZNY*, undertake to sign such further documents to effect the aforesaid sale, transfer, and assignment as may be required from time to time, without reimbursement, but at the expense of *ATI Technologies U.L.C.*

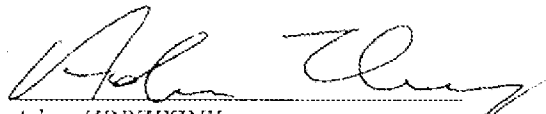
August EXECUTED at Markham, Ontario, Canada this 28 day of
, 2007.


Neil MCLELLAN

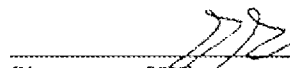
I, YIP SENG LOW, whose full post office address is
224 SOUTH PARK ROAD, THORNHILL L3T 7X4 ON, CANADA
hereby declare that I was personally present and did see Neil Mclellan, who is personally known
to me to be the person named in the above assignment, duly sign and execute the same.


Signature of Witness

August EXECUTED at Markham, Ontario, Canada this 28 day of
, 2007.


Adam ZBRZEZNY

I, YIP SENG LOW, whose full post office address is
224 SOUTH PARK ROAD, THORNHILL L3T 7X4 ON, CANADA
hereby declare that I was personally present and did see Adam Zbrzezny, who is personally
known to me to be the person named in the above assignment, duly sign and execute the same.


Signature of Witness